

# **Small Signal Zener Diode**

#### **General Description**

These diodes small signal Zener diodes, fabricated in planar technology. Miniature surface mount package is excellent for hand-held and portable applications where is space is limited.

#### **SOD-323**

#### **Features and Benefits**

- Silicon epitaxial planar diode
- Low Zener impedance and low leakage current
- Standard Zener voltage tolerance is 4.3%.
- Full lead (Pb)-free device and RoHS compliant device
- · Available in "Green" device



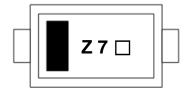
#### **Applications**

Voltage regulator

#### **Ordering Information**

Part Number	Marking Code	Package	Packaging
SDZ8V2D	<b>Z7</b> □	SOD-323	Tape & Reel

#### **Marking Information**



**Z7 = Specific Device Code** 

☐ = Year & Week Code Marking

= Color band denote cathode

#### **Pinning Information**

Pin	Description	Simplified Outline	Graphic Symbol	
1	Cathode	1 2		
2	Anode		<b>⊣_~</b> -	

### **Absolute Maximum Ratings** (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Power dissipation 1)	P <sub>D</sub>	200	mW
Operating junction temperature	TJ	150	00
Storage temperature range	T <sub>stg</sub>	-55 to +150	°C

<sup>1)</sup> Device mounted on FR-4 board with recommended pad layout.

## Thermal Characteristics (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Thermal resistance, junction to ambient 1)	R <sub>th(j-a)</sub>	625	°C/W

<sup>1)</sup> Device mounted on FR-4 board with recommended pad layout.

## **Electrical Characteristics** (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Zener voltage	Vz	I <sub>Z</sub> =5mA	7.84	-	8.56	V
Dynamic impedance	Z <sub>ZT</sub>	I <sub>Z</sub> =5mA	-	-	7	
KNEE dynamic impedance	Z <sub>ZK</sub>	I <sub>Z</sub> =0.25mA	-	-	600	Ω
Reverse leakage current	I <sub>R</sub>	V <sub>R</sub> =6.5V	-	-	0.5	uA

## SDZ8V2D

## **Rating and Characteristic Curves**

Fig. 1) Typical Zener Characteristics

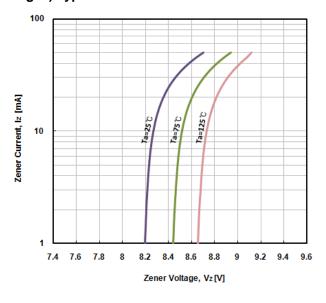


Fig. 3) Typical Total Capacitance Characteristics

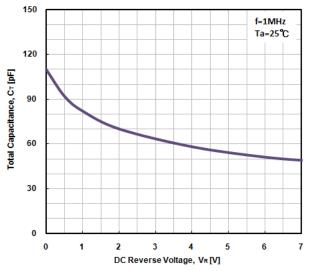


Fig. 2) Typical Forward Characteristics

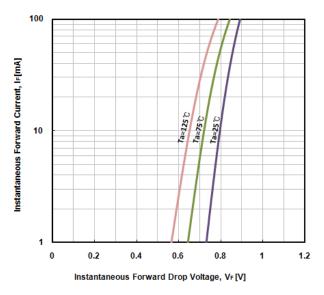
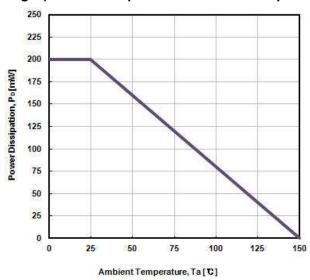
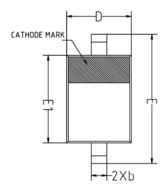


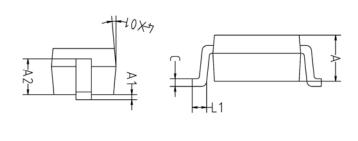
Fig. 4) Power Dissipation vs. Ambient Temperature



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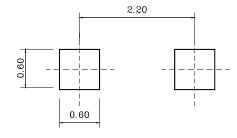
## Package Outline Dimensions (Unit: mm)





SYMBOL	١	NOTE		
3111001	MINIMUM	NOMINAL	MAXIMUM	NOTE
Α	0.850	-	0.950	
A1	0.000	-	0.100	
A2	0.650	0.700	0.750	
b	0.250	0.300	0.350	
С	0.110	0.150	0.190	
D	1.200	1.250	1.300	
E	2.400	2.500	2.600	
E1	1.650	1.700	1.750	
L1	0.200	-	0.300	
<del>0</del> 2		5° REF		

## **X** Recommend PCB solder land (Unit : mm)



SDZ8V2D

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